

plastic dual in-line package; 28 leads (600 mil)
8 February 2016

**Package information** 

# 1. Package summary

Terminal position code D (double) Package type descriptive code DIP28

DIP28 Package type industry code

Package style descriptive code DIP (dual in-line package)

Package style suffix code NA (not applicable)

Package body material type P (plastic) IEC package outline code 051G05 JEDEC package outline code MO-015 JEITA package outline code SC-510-28

Mounting method type T (through-hole mount)

13-2-2003 Issue date

### **Table 1. Package summary**

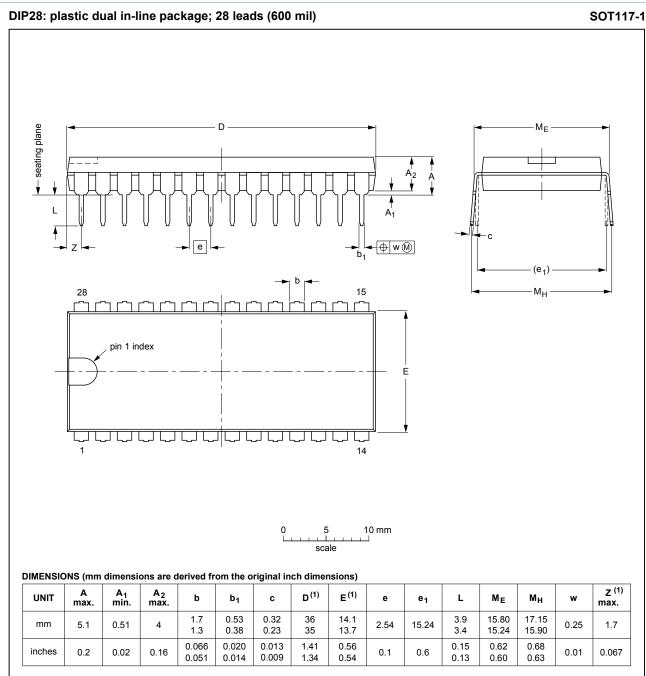
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	35	-	35.7	36	mm
E	package width	13.8	-	13.8	14.1	mm
Α	seated height	[tbd]	-	5.1	5.1	mm
A <sub>2</sub>	package height	[tbd]	-	3.85	4	mm
n <sub>2</sub>	actual quantity of termination	-	-	28	-	



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# 2. Package outline



#### Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT117-1	051G05	MO-015	SC-510-28			<del>99-12-27</del> 03-02-13	

Fig. 1. Package outline DIP28 (SOT117-1)

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## 3. Legal information

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